



S&H Form: (2/01)
DOCKET NO. - 1509.1021-RED

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Hideo SHIMADA et al.

Serial No: 10/662,947

Group Art Unit: 2833

Confirmation No. 1496

Filed: September 16, 2003

Examiner: Unassigned

For: IC SOCKET FOR ELECTRICAL PARTS WITH IMPROVED ELECTRICAL CONTACT

REQUEST FOR CORRECTED FILING RECEIPT

Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

Sir:

It is requested that the title on the Official Filing Receipt be corrected. The correct title is **IC SOCKET FOR ELECTRICAL PARTS WITH IMPROVED ELECTRICAL CONTACT**, as is evidenced by the Reissue Declaration, attached to the application as filed. For the convenience of the Patent and Trademark Office, attached is a photocopy of the original receipt on which the errors have been noted in red.

It is requested that a corrected Official Filing Receipt be issued in this application.

Respectfully submitted,

STAAS & HALSEY LLP

Date: April 1 2004

By: Mark J. Henry
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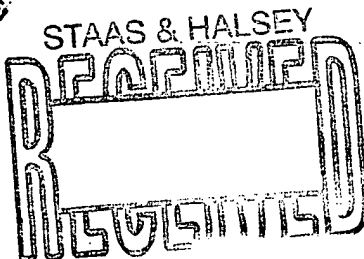
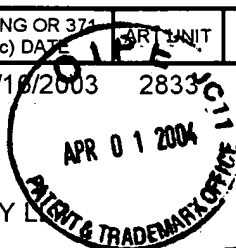


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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/662,947	09/18/2003	2833	834	1509.1021-RED	14	8	4

21171
 STAAS & HALSEY LLP
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 WASHINGTON, DC 20005



CONFIRMATION NO. 1496

FILING RECEIPT



OC000000011637067

Date Mailed: 01/07/2004

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Hideo Shimada, Kawaguchi-shi, JAPAN;
 Kentaro Mori, Kawaguchi-shi, JAPAN;

Assignment For Published Patent Application

Enplas Corporation, Kawaguchi-shi, JAPAN;

Domestic Priority data as claimed by applicant

This application is a DIV of 10/207,816 07/31/2002
 which is a REI of 09/319,127 06/01/1999 PAT 6,296,503

Foreign Applications

JAPAN 9-287963 10/03/1997
 JAPAN 9-344024 11/28/1997

If Required, Foreign Filing License Granted: 01/07/2004

Projected Publication Date: To Be Determined - pending completion of Corrected Papers

Non-Publication Request: No

Early Publication Request: No

Title

IC Socket for electrical parts with improved electrical contact

Preliminary Class

439

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Title 35, United States Code, Section 184
Title 37, Code of Federal Regulations, 5.11 & 5.15**

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NOT GRANTED

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S&H Form: (2/01)

Docket No.: 1509.1021-RE

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Reissue of Patent No.: 6,296,503

Issued: October 2, 2001

Hideo SHIMADA et al.

Group Art Unit:

Filed:

Examiner:

For: IC SOCKET FOR ELECTRICAL PARTS WITH IMPROVED ELECTRICAL CONTACT

REISSUE DECLARATION UNDER 37 C.F.R. § 1.175

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

We, Hideo Shimada and Mori Kentaro, declare that:

1. Our residence, post office addresses and citizenships are as stated below next to our names.

2. We believe we are the original, first and joint inventors of the subject matter which is described and claimed in U.S. Letters Patent No. 6,296,503 ("503 patent") granted on October 2, 2001, and for which invention we solicit a reissue patent on the invention entitled IC SOCKET FOR ELECTRICAL PARTS WITH IMPROVED ELECTRICAL CONTACT, the specification of which is attached hereto.

3. We hereby state that we have reviewed and understand the contents of the above-identified specification, including the claims as amended in the attached reissue application.

4. We acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information which is material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56.

5. We hereby claim foreign priority benefit under Title 35, United States Code, Section 119, of Japanese Patent Application No. 9-287963 filed October 3, 1997 and Japanese Patent Application No. 9-344024 filed November 28, 1997, and there are no other foreign applications for patent or inventor's certificate having a filing date before Japanese Patent Application Numbers 9-287963 and 9-344024 on which priority is claimed.

6. We verily believe the original '503 patent to be wholly or partly inoperative or invalid by reason of patentees' claiming more or less than they had the right to claim in the patent.

7. With respect to the claims, one error relied upon as the basis for the reissue is the failure to claim a "method of mounting an electrical part" as claimed in claim 13.

8. All errors including those listed above, which are being corrected up to the time of filing this reissue declaration, arose without any deceptive intention on the part of the applicant.

9. We hereby appoint the following attorneys and/or agents to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

James D. Halsey, Jr., Reg. No. 22,729; Harry John Staas, Reg. No. 22,010; David M. Pitcher, Reg. No. 25,908; John C. Garvey, Reg. No. 28,607; J. Randall Beckers, Reg. No. 30,358; William F. Herbert, Reg. No. 31,024; Richard A. Gollhofer, Reg. No. 31,106; Mark J. Henry, Reg. No. 36,162; Paul I. Kravetz, Reg. No. 35,230; Gene M. Garner II, Reg. No. 34,12; Michael D. Stein, Reg. No. 37,240; Jon H. Muskin, Reg. No. 43,824, Stephen Boughner, Reg. No. 45,317, John H. Stowe, Reg. No. 32,863, C. Joan Gilsdorf, Reg. No. 43,635, Mehdi Sheikerz, Reg. No. 41,307, James G. McEwen, Reg. No. 41,983, Michael J. Badagliacca, Reg. No. 39,099, Heath E. Wells, Reg. No. 43,257, James T. Strom, Reg. No. 48,702, Eric Berkowitz, Reg. No. 44,030, Patrick J. Stanzione, Reg. No. 40,434, Charles Y. Park, Reg. No. P-50, 709, Matthew Q. Ammon, Reg. No. 50,346, Derrick L. Fields, Reg. No., P-50,133, and Seungman Kim, Reg. No. 50,102.

Please send all correspondence related to the above-identified application to the following address:

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21171

PATENT TRADEMARK OFFICE

10. We hereby declare that all statements made herein of our own knowledge are true, that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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